

FEATURE:

※ Power switching application

※ Uninterruptible power supply

* Hard switched and high frequency circuits

※ Excellent package for good heat dissipation※ Good stability and uniformity with high EAS

※ Fully characterized avalanche voltage and current

SHENZHEN MENGKE ELECTRONICS TECHNOLOGY CO., LTD TO-252/251 Plastic-Encapsulate MOSFETS

MK6003N

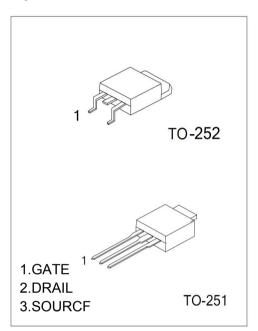
N-Channel 60-V(D-S) Power MOSFET

V(BR)DSS	RDS(on)MAX	ID
60 V	40mΩ@ 10 V	30A
60 V	45mΩ@ 4.5 V	30A

General Description:

The high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition , this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes . The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power suppliers, converters and PWM motor controls , these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

Equivalent Circuit:



2. Drain

SYMBOL: 1.Gate 0 3.Source

Maximum ratings (Ta=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	VDS	60	V
Gate-Source Voltage	VGS	±20	V
Continuous Drain Current	ID	30	•
Pulsed Diode Curren	IDM	40	A
Power Dissipation	PD	50	W
Thermal Resistance from Junction to Ambient (t≤10s)	RθJA	100	°C/W
Operating Junction	erating Junction TJ 150		°C
Storage Temperature	TSTG	-55~+150	°C

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MOSFET ELECTRICAL CHARACTERISTICS

Static Electrical Characteristics (Ta = 25 $^{\circ}$ C Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Static						
Drain-source breakdown voltage	V(BR)DSS	VGS = 0V, ID = 250µA	60			V
Gate-source threshold voltage	VGS(th)	VDS =VGS, ID = 250µA	1		3	V
Gate-source leakage	IGSS	VDS =0V, VGS = ±20V			±100	nA
Zero gate voltage drain current	IDSS	VDS = 60V, VGS =0V			1	μA
		VGS = 10V, ID = 10A		33	40	mΩ
Drain-source on-state resistancea	RDS(on)	VGS = 4.5V, ID = 5A		38	45	mΩ
Forward transconductancea	gfs	VDS = 25V, ID = 30A		10		S
Diode forward voltage	VSD	IS= 2A, VGS=0V		0.85	1.5	V
Dynamic						
Input capacitance	Ciss	VDS = 25V,VGS =0V, f=1MHz		500		pF
Output capacitance	Coss			150		pF
Reverse transfer capacitanceb	Crss			82		pF
Total gate charge	Qg			31		nC
Gate-source charge	Qgs	VDS = 30V,VGS = 10V, ID = 20A		10		nC
Gate-drain charge	Qgd	12 20/1		6		nC
Switchingb	•					
Turn-on delay time	td(on)			10		ns
Rise time	tr	VDD= 30V		23		ns
Turn-off delay time	td(off)	RL= 25Ω, ID = 20A, VGEN= 10V,Rg= 25Ω		64		ns
Fall time	tf			31		ns
Drain-Source Diode Characteri	stics			•	•	
Continuous Source-Drain Diode Current	IS				30	А
Pulsed Diode forward Curren	ISM				80	А

Note :

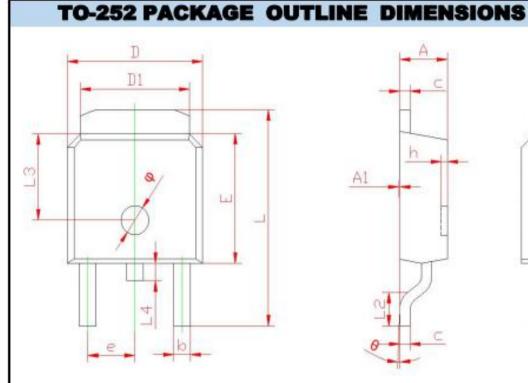
- 1. Repetitive Rating : Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t < 10 sec.
- 3. Pulse Test : Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production testing.

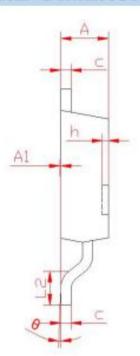
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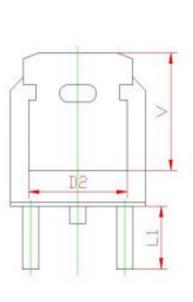


SHENZHEN MENGKE ELECTRONICS TECHNOLOGY CO., LTD

PACKAGE OUTLINE DIMENSIONS :





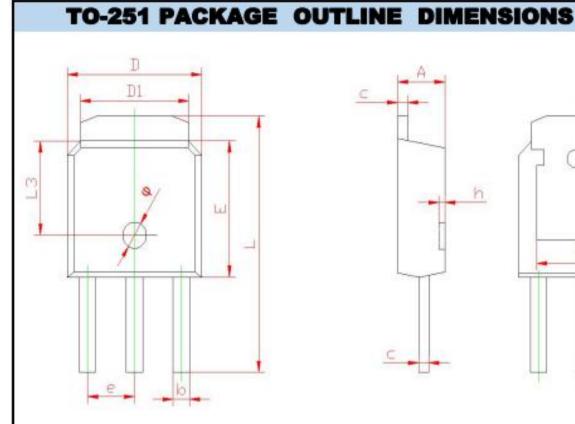


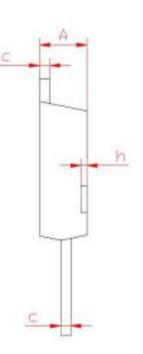
Symbol	Dimensions	in Millimeters	Dimensions in Inches	
	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
C	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.80	0 REF	0.18	9 REF
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.90	0 REF	0.114 REF	
L2	1.400	1.700	0.055	0.067
L3	4.00	REF	0.15	7 REF
L4	0.600	1.000	0.024	0.039
φ	1.200	1.400	0.043	0.051
θ	0°	<mark>8°</mark>	0°	<mark>8°</mark>
h	0.000	0.300	0.000	0.012
V	5.50	0 REF	0.21	7 REF

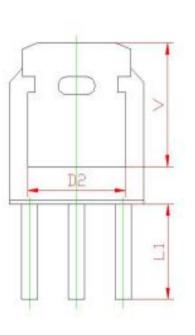


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A	2.200	2.400	0.087	0.094	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.800	REF	0.189 REF		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	11.100	11.700	0.437	0.461	
L1	4.300 REF		0.17	REF	
L3	4.00 REF		0.16	REF	
φ	1.200	1.400	0.043	0.051	
h	0.000	0.300	0.000	0.012	
V	5.50	D REF	0.21	7 REF	